High-resolution imaging of elastic properties using harmonic cantilevers

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Abstract
We present a micromachined scanning probe cantilever, in which a specific higher-order flexural mode is designed to be resonant at an exact integer multiple of the fundamental resonance frequency. We have fabricated such cantilevers by reducing the stiffness of the third order flexural mode relative to the fundamental mode, and we have demonstrated that these cantilevers enable sensing of non-linear mechanical interactions between the atomically sharp tip at the free end of the cantilever and a surface with unknown mechanical properties in tapping-mode atomic force microscopy. Images of surfaces with large topographical variations show that for such samples harmonic imaging has better resolution than standard tapping-mode imaging.

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1. Introduction
Atomic force microscope (AFM) [1] has proven to be an exceptionally useful tool for mapping topography of surfaces at the nanoscale. In an AFM, a flexible cantilever with an atomically sharp tip is brought to the vicinity of a sample surface and the deflections of the cantilever as a result of the attractive and repulsive forces between the tip and the sample are monitored while the cantilever is scanned across the surface.

The earliest AFM imaging techniques required continuous contact between the tip and sample, which resulted in frictional forces that damage both the tip and the sample. To overcome this problem, dynamic imaging techniques that do not require continuous tip-sample contact have been introduced. Among these, tapping-mode atomic force microscope (TM-AFM) [2] has become the most widely used. In TM-AFM (Fig. 1), the cantilever is vibrated at a frequency close to one of its flexural resonances in vicinity of the surface under test so that the tip makes intermittent contacts (tapping) with the surface once in every oscillation period. During the scan across the surface, the amplitude of vibration is maintained at a constant value through a feedback loop that adjusts the height of the cantilever base. The feedback signal therefore reflects the topography of the surface.

Apart from high-resolution topography imaging, there has been a great deal of interest in using AFM as a tool to probe the hardness and elasticity at the nanoscale. Imaging of elastic properties enables detection of variations in chemical composition across the surface, characterization of thin films, and studies of nanomechanical structures in general. With an AFM one can measure the contact stiffness between the nano-tip and the sample, which is a measure of the elasticity of the material in the vicinity of the contact. Various techniques for measuring contact stiffness has been developed, including quasi-static ones that apply force to the sample and measure the indentation of the surface simultaneously [3,4], and dynamic ones that either vibrate the cantilever or the sample and measure variations in the response of the cantilever which is affected by the elasticity of the sample [5–9]. These techniques require continuous tip-sample contact and therefore, they pose the same problems as contact-mode imaging. Such techniques are not suitable for imaging soft samples like biological samples and polymers. The techniques that have been demonstrated also have not achieved sufficient sensitivity and simplicity for practical imaging.

Studies of cantilever dynamics in TM-AFM have shown that the vibration spectrum of tapping cantilevers exhibit peaks at integer multiples (higher harmonics) of the excita-
Fig. 1. Schematic of tapping-mode operation. A cantilever with a tip is vibrated with a piezo-element and its deflection amplitude is monitored and kept constant with an optical lever detection system and a feedback controller.

Fig. 2. Tip position (a) with respect to sample surface (dashed line) in TM-AFM and tip–sample interaction forces (b). Negative tip displacement means that tip indents the sample surface.

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These harmonics are generated by the non-linearity of the tip–sample interaction and carry information about the mechanical properties of the sample on a nanometer spatial scale [11]. Imaging with these higher harmonics has been demonstrated and the result has shown good contrast based on material properties [12]. Unfortunately, the vibration amplitudes of traditional AFM cantilevers at higher harmonics are too small for practical AFM imaging [13]. Here we report a new micromachined cantilever, the harmonic cantilever, which will enable practical and non-destructive measurement of elasticity on both soft and hard samples with a good accuracy by enhancing the non-linear energy transfer to higher harmonics in TM-AFM.

2. Theory

In TM-AFM the cantilever is vibrated at its fundamental resonance frequency with sufficiently large amplitudes (10-100 nm) to avoid sticking. The distance between the sample surface and the rest position of the tip is kept shorter than the free vibration amplitude so that tip hits the surface once every period. Therefore, the amplitude of the cantilever vibration is reduced to the tip–sample separation. The duration of the intermittent contacts can be as long as 15% of the oscillation period, depending on the hardness of the sample [14]. On softer samples the tip can indent the sample surface more and spend more time in contact. Other than the repulsive forces that appear when the tip indents the surface, there are also attractive forces between the tip and the sample. The origins of these attractive forces are mainly capillary forces and Van der Waals forces. They appear when the tip gets closer to the surface. An illustration of the interaction forces and tip displacement is given in Fig. 2. In general, the attractive forces are higher when the tip retracts. This is either due to a hysteresis in Van der Waals forces or due to formation and disruption of a liquid neck.

The periodic nature of tip–sample forces results in higher-order Fourier components (harmonics) exactly at integer multiples of the vibration frequency of the cantilever.
The magnitudes of these harmonics mainly depend on the contact time and peak force. For illustrative purposes we modeled the sample with a linear spring and neglected the attractive forces. Under these circumstances, the interaction forces become a clipped sine wave. In Fig. 3, we plot the magnitudes of the harmonic forces calculated with this model for three different contact times, 4%, 8% and 12% corresponding to hard medium and soft samples. In order to compare the three different cases, we assumed that the average force (0th order Fourier component) is the same in all of them [15,16]. Then we normalized the magnitudes of the harmonics to the 0th order Fourier component. These plots show that the higher-order components, especially the ones around 15th harmonic in our example, depend highly on the contact time. Therefore, one can argue that in TM-AFM the information about the sample elasticity...
is in the higher harmonics of the tip-sample interaction forces. The higher harmonics are all driven by the forces acting on the cantilever tip. The actual cantilever displacements at these frequencies therefore depend on the transfer function of the cantilever relating displacement to the tip force. That is, the higher harmonic forces, which have frequencies close to resonances of the cantilever, will generate larger vibration amplitudes. Fig. 4 gives the transfer function of a rectangular cantilever whose fundamental resonance frequency is normalized to 1. The higher harmonics that are closest to the resonance peaks are also marked on the curve. Typical quality factors of each resonance are on the order of several hundreds. For a randomly picked cantilever it is therefore very unlikely that one of the higher harmonics coincides with one of the resonances of the cantilever. As a result of this, none of the higher harmonics of a typical cantilever makes use of the high transfer function at the resonance peaks.

3. Harmonic cantilever

We have designed and fabricated an AFM cantilever with increased vibration amplitude at higher harmonics by matching a higher-order natural resonance to an integer multiple of the fundamental resonance frequency. Specifically, we matched the third order flexural resonance frequency to the 16th harmonic of the fundamental. Note that the 16th harmonic is very sensitive to contact time variations (see Fig. 3).

3.1. Design approach

Tuning the resonance frequency of the third order mode is achieved by appropriately removing mass from regions where the cantilever has high mechanical stress in that
particular mode, thereby reducing elastic energy and the resonance frequency of the mode. To illustrate this, the first three flexural mode shapes of a rectangular cantilever with a notch are given in Fig. 5. The cantilever is fixed at the base and free at the other end. The notch is located at one of the curved regions of the third mode. Note that this location does not correspond to a highly curved region in the first two modes. Therefore, the effect of the notch in reducing the elastic energy is more prominent in the third mode. In addition to the elastic energy, the kinetic energy in a mode also affects the resonant frequency of a mode. These two forms of energy correspond to the effective spring constant (elastic energy) and effective mass (kinetic energy) of a mode. Since removal of mass changes the mass distribution of the cantilever, it also affects the kinetic energies in each mode. Therefore, the effect of variations in the kinetic energy has to
be taken into account while designing a harmonic cantilever. In our case, when the mass is removed from the curved region of the third flexural mode as shown in Fig. 5, variations in the elastic energy are more significant than in kinetic energy. This is because at the location of the notch, both the first and the third modes have similar displacements. However, the curvature in the third mode at that location is much higher than its counterpart in the first mode. Also, the second mode is minimally affected because the location of the notch is close to a node of that mode where the curvature and the displacement are both small. Please refer to Stark and Heckl [17] for analytical expressions on the effective masses and spring constants of the modes of a cantilever.

3.2. Fabrication

Instead of tuning the resonances with by creating notches at a given location, we preferred opening holes in the cantilevers at these same locations. This way the cantilevers will be more stable in terms of torsional vibrations. A scanning electron micrograph image of a harmonic cantilever is given in Fig. 6. With finite element analysis, the hole in the cantilever is designed to give the correct value for the resonance frequency of the third order flexural mode. However, a series of cantilevers were fabricated with slightly different hole sizes (2.5 μm steps in width perpendicular to the length of the beam) to allow for dimensional variation due to the fabrication process.

The fabrication of harmonic cantilevers is a three-mask process. The schematic of the process steps is given in Fig. 7. First, the tip masks (a) are transferred to an oxide/nitride hard mask on the device layer of an SOI wafer (b). Tips are plasma etched (c) and oxide sharpened (d). The second mask defines the cantilever geometry, including the holes (e). The cantilever pattern is transferred to the nitride and oxide layers by plasma etch and buffered oxide etch. Then the cantilevers are formed in a plasma etch (f). The front and back side of the wafer is then covered with nitride (g), and the back side is patterned for KOH etching (h). After etching through the wafer, the cantilevers are released by removing the protective nitride layer in plasma etch and removing the oxide in a buffered oxide etch (i).

Non-uniform etch rates resulted in variations in cantilever thicknesses, which in turn translated into variations in the...
In Fig. 9, the spectrum around the 15th–17th harmonics is the third resonance frequency of the harmonic cantilever. Because the frequency of that particular harmonic matches relatively higher signal level compared to its neighbors. That is harmonic cantilever. Especially the 16th harmonic has relatively higher signal level compared to its neighbors. These are the harmonics that are closest to the resonance frequencies of the harmonic cantilever. Especially the 16th harmonic has relatively higher signal level compared to its neighbors. That is because the frequency of that particular harmonic matches the third resonance frequency of the harmonic cantilever. In Fig. 9, the spectrum around the 15th–17th harmonics is given when third resonance frequency is exactly equal to 16 times the driving frequency (a) and when there is a slight mismatch (b). This result shows that our correctly-designed cantilevers improve the higher-harmonic signal by 15–20 dB.

In order to demonstrate the sensitivity of imaging at the higher harmonics with harmonic cantilevers, we recorded images of the surface of a photomask with a surface composed of borosilicate glass (modulus of elasticity = 63 GPa) and chromium (modulus of elasticity = 248 GPa). In Fig. 10 the TM-AFM topography image (top) and the image at the 16th harmonic (bottom) is depicted together with the oscilloscope traces of the topography and 16th harmonic signal. These figures show that imaging at the 16th harmonic can distinguish between the two materials to a good degree. These images are taken simultaneously and the left side of each image is the glass side and right side is the chromium side. Since the chromium is stiffer than the borosilicate glass, we expect the contact time to be shorter on chrome side. Fig. 3 suggests that shorter contact time results in larger signals at the 16th harmonic. The oscilloscope traces in Fig. 10 show that the signal at the 16th harmonic is higher on the chrome side as predicted. Additionally, metal traces and/or dust particles on the glass side are quite visible in the 16th harmonic image, demonstrating a better signal-to-noise than in the topographical image. This illustrates a potential additional advantage of higher-harmonic imaging: Surfaces with large topographical differences can be imaged with better resolution than in standard TM-AFM.

5. Conclusion

The specially micromachined cantilever presented in this report enables tapping-mode higher harmonic imaging, which is proven to be a sensitive technique for measurement of elasticity of surfaces at the nanoscale. Higher harmonic imaging in TM-AFM provides a non-destructive and practical way to map elasticity variations across a surface, and might have advantages for high-resolution imaging of samples with large topography variations.

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References


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